Jitter minimizing techniques for digitally isolated high speed, high SNR (2.0 Msps, 18b) analog input DAQ

Project Title:

Designed for:

Assembly Variant:

ADS9110 w/REF5045

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Version control disabled

Revision History

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For Corner Mounting

For PH11 Mounting

For Beagle Bone Block Mounting

For PH12 Mounting

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